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FCD1300N80Z N-Channel SuperFET[®] II MOSFET

800 V, 4 A, 1.3 Ω

Features

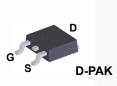
- R_{DS(on)} = 1.05 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q_q = 16.2 nC)
- Low E_{oss} (Typ. 1.57 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 48.7 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

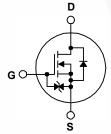
Applications

- · AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

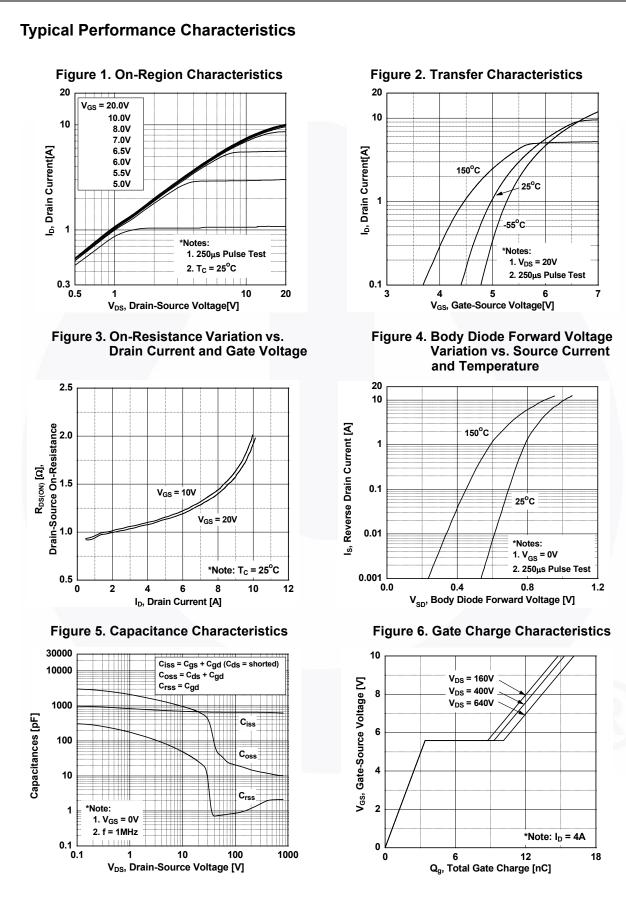
Symbol		FCD1300N80Z	Unit			
V _{DSS}	Drain to Source Voltage			800	V	
V _{GSS}	Cata ta Causa Maltana	- DC		±20	- V	
	Gate to Source Voltage	- AC	±30			
ID	Drain Current	- Continuous (T _C = 25 ^o C)		4	•	
	Drain Current	- Continuous (T _C = 100 ^o C)		2.5	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	12	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2			48	mJ	
I _{AR}	Avalanche Current (Note 1)			0.8	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.26	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Power Dissipation	(T _C = 25°C)		52	W	
	Power Dissipation	- Derate Above 25°C		0.42	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCD1300N80Z	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.4	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	100	0/11

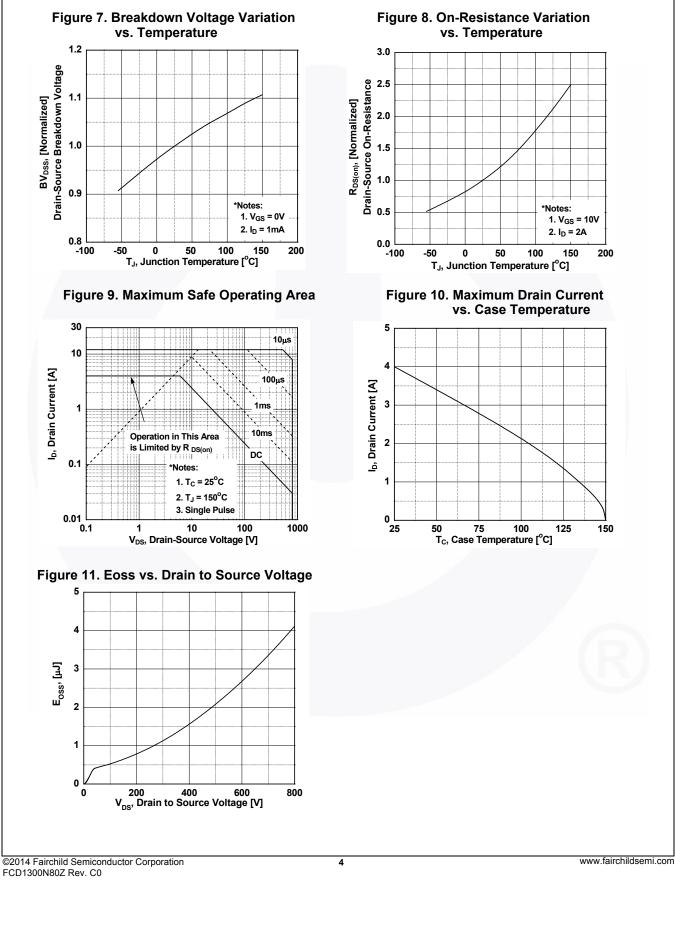
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i uit itui	nber	Top Mark P		Packing Method	Reel S	ize	Tape Wio	dth	Quantity	
FCD1300	N80Z	FCD130080Z	DPAK	Tape and Reel	330 m	ım	16 mm	1	2500 units	
Electrica	Chara	cteristics T _C = 25%	C unless ot	herwise noted.						
Symbol	Parameter			Test Conditions			Тур.	Max.	Unit	
Off Charac	teristics								÷	
BV _{DSS}	Drain to Source Breakdown Voltage		e V _{GS}	V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C			-	-	V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current			$I_D = 1$ mA, Referenced to 25°C			0.85	-	V/ºC	
I _{DSS}				$V_{DS} = 800 V, V_{GS} = 0 V$ $V_{DS} = 640 V, V_{GS} = 0 V, T_C = 125^{\circ}C$			-	25 250	μΑ	
I _{GSS}	Gate to B	ody Leakage Current		= ±20 V, V _{DS} = 0 V	5- 120 0	-	-	±10	μA	
On Charac	teristics									
V _{GS(th)}		eshold Voltage	V _{GS}	= V _{DS} , I _D = 0.4 mA		2.5	-	4.5	V	
R _{DS(on)}	Static Dra	in to Source On Resistan		= 10 V, I _D = 2 A		-	1.05	1.3	Ω	
9FS	Forward 7	Fransconductance		= 20 V, I _D = 2 A		-	4.5	-	S	
Dynamic C	haracter	istics								
C _{iss}	Input Cap	acitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		-	661	880	pF	
C _{oss}	Output Ca	apacitance				-	22.3	30	pF	
C _{rss}	Reverse 7	Fransfer Capacitance				-	0.74	-	pF	
C _{oss}	Output Ca	apacitance	V _{DS}	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz			11.4	-	pF	
C _{oss(eff.)}	Effective	Output Capacitance	V _{DS}	$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	48.7	-	pF	
Q _{g(tot)}	Total Gate	e Charge at 10V	V _{DS}	V _{DS} = 640 V, I _D = 4 A, V _{GS} = 10 V		-	16.2	21	nC	
Q _{gs}	Gate to S	ource Gate Charge				-	3.5	-	nC	
Q _{gd}	Gate to D	rain "Miller" Charge			(Note 4)	-	6.8	-	nC	
ESR	Equivalen	t Series Resistance	f = 1	MHz		-	4	-	Ω	
Switching	Characte	eristics								
t _{d(on)}	Turn-On [Delay Time		V_{DD} = 400 V, I _D = 4 A, V _{GS} = 10 V, R _g = 4.7 Ω		-	14	38	ns	
t _r	Turn-On F	Rise Time				-	8.3	27	ns	
t _{d(off)}	Turn-Off	Delay Time	V _{GS}			-	33	76	ns	
t _f	Turn-Off F	Fall Time		(Note 4)			6	22	ns	
Drain-Sour	ce Diode	e Characteristics								
I _S	Maximum	Continuous Drain to Sou	rce Diode	Forward Current		-	-	4	A	
I _{SM}	Maximum	Pulsed Drain to Source I	Diode Forw	ard Current		-	-	12	A	
V _{SD}	Drain to S	ource Diode Forward Vol	tage V _{GS}	$V_{GS} = 0 V, I_{SD} = 4 A$			-	1.2	V	
	Reverse F	Recovery Time		$V_{GS} = 0 V, I_{SD} = 4 A,$ $dI_F/dt = 100 A/\mu s$		-	275	-	ns	
t _{rr}							2.9	1	μC	

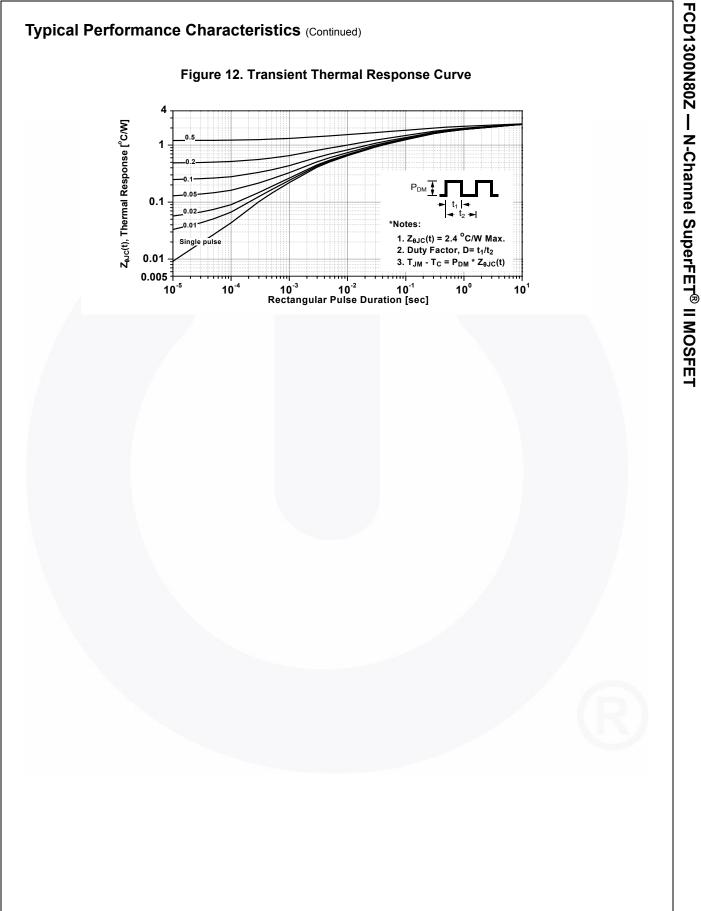


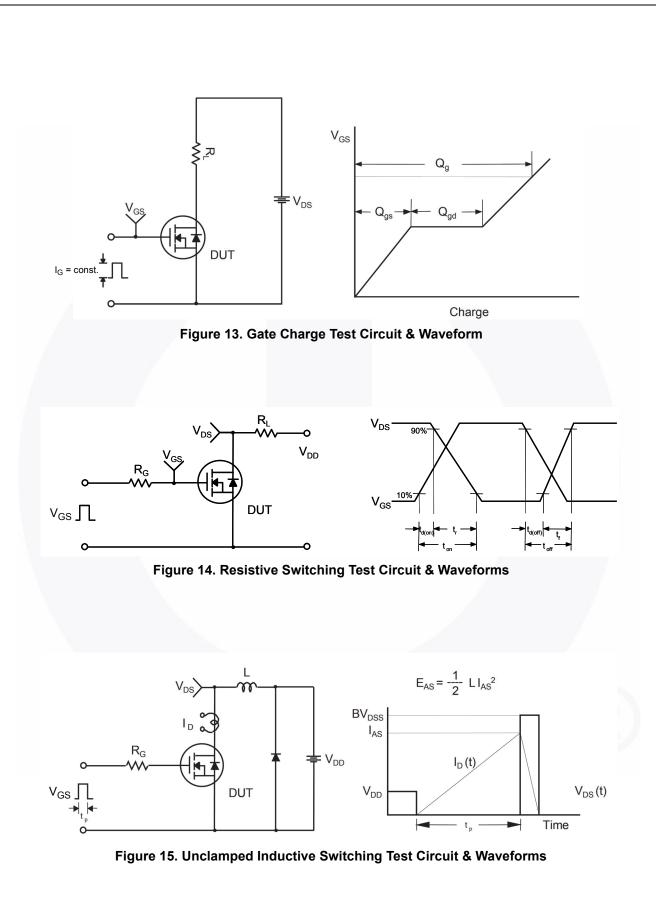
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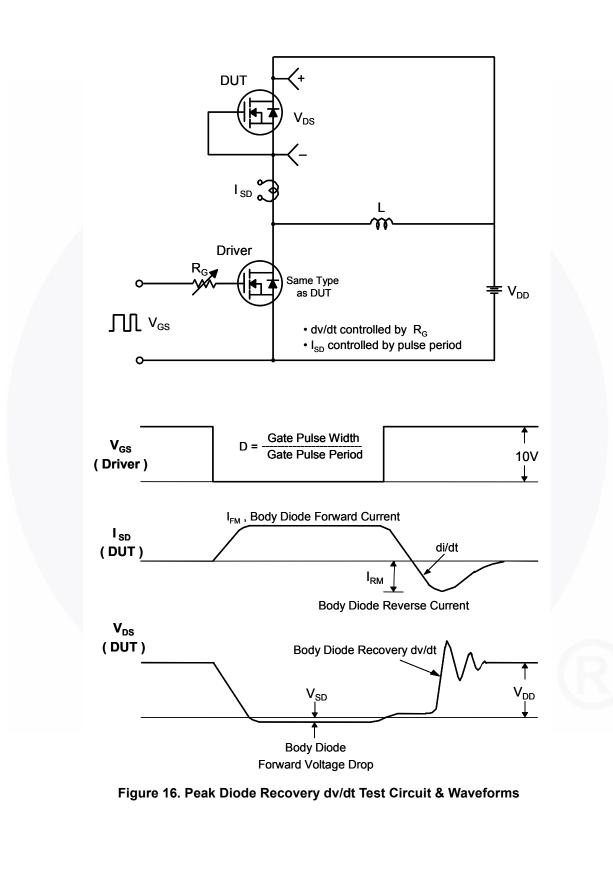




Typical Performance Characteristics (Continued)









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